

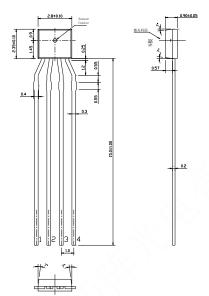
MW922 InSb Hall Element

Ultra High-sensitivity InSb Hall element

Thin-type SIP Package

Shipped in Bulk by Pack (500Pcs devices per pack)

Dimensional Drawing (Unit: mm)



| | 引脚定义 (Pinning) | | |
|---|----------------|-------|-------|
| | 输入 Input | 1 (±) | 3 (∓) |
| ĺ | 输出 Dutput | 2 (±) | 4 (∓) |

Absolute Maximum Rating

Operating Temperature Range Storage Temperature Range Maximum Input Current J_{cmax} Maximum Input Voltage V_{cmax} -40°C ~ 125°C -55°C ~ 150°C 20mA 2V

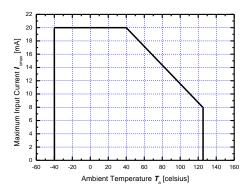


Figure 1. 1 Maximum Input Current Icmax

Copy Right Reserved JZWI-DS-011 Version 2.3

Matrixopto.Co.,Ltd is the owner of the trademarks used in this document, which has the exclusive right to prevent any third parties not having the owner's consent from using in the course of trade identical or similar signs for goods or services where such use would result in a likelihood of confusion.



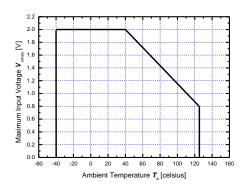


Figure 1. 2 Maximum Input Voltage V_{cmax}

Electrical Characteristics (RT=25°C)

Symbol Item Test Condi. Min. Тур. Max. Unit $B = 50 \text{mT}, \ V_{C} = 1 \text{V}$ Hall Voltage $V_{\rm H}$ 310 415 mV $T_a = RT$ B = 0mT, $I_C = 0.1mA$ 240 Input Resistance 550 Ω R_{in} $T_a = RT$ $B = 0mT, I_C = 0.1mA$ **Output Resistance** 240 **R**out 550 Ω $T_a = RT$ $B = 0mT, V_C = 1V$ Offset Voltage V_{os} -7 +7 mV $T_a = RT$ $B = 50 \text{mT}, I_C = 5 \text{mA},$ Temp. Coeffi. of V_H αV_H %/°C -1.8 $T_a = 0$ °C ~ 40°C B = 0mT, $I_C = 0.1mA$, Temp. Coeffi. of Rin %/°C αR_{in} -1.8 $T_a = 0^{\circ}C \sim 40^{\circ}C$

Table 1. Electrical Characteristics of MW922.

Note:

1. $V_{\rm H} = V_{\rm H-M} - V_{\rm os}$

In which $V_{\text{H-M}}$ is the Output Hall Voltage, V_{H} is the Hall Voltage and V_{os} is the offset Voltage under the identical electrical stimuli.

2.
$$\alpha V_H = \frac{1}{V_H(T_1)} \times \frac{V_H(T_3) - V_H(T_2)}{(T_3 - T_2)} \times 100$$

3.
$$\alpha R_{in} = \frac{1}{R_{in}(T_1)} \times \frac{R_{in}(T_3) - R_{in}(T_2)}{(T_3 - T_2)} \times 100$$

$$T_1 = 20^{\circ}\text{C}, \qquad T_2 = 0^{\circ}\text{C}, \qquad T_3 = 40^{\circ}\text{C}$$



Classification of Output Hall Voltage (V_H)

Table 2. Classification of Hall Voltage

| Rank | V _H [mV] | Conditions | |
|------|----------------------------|-----------------------------------|--|
| G | 310 ~ 370 | B=50mT, V _C =1V | |
| Н | 360 ~ 415 | | |

Characteristic Curves

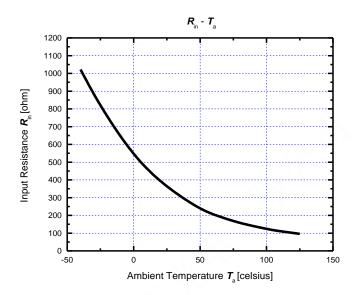


Figure 2. Input resistance R_{in} as a function of ambient temperature $T_{a.}$

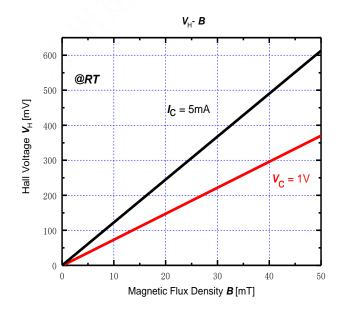


Figure 3. Hall voltage V_H as a function of magnetic flux density B.

Copy Right Reserved JZWI-DS-011 Version 2.3



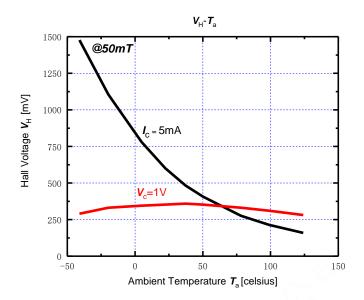


Figure 4. Hall voltage V_H as a function of ambient temperature $T_{a.}$

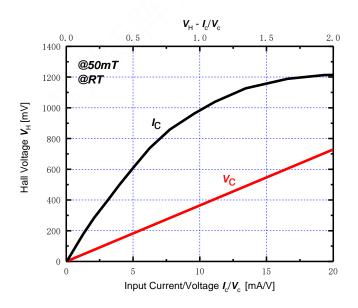


Figure 5. Hall voltage V_H as a function of electrical stimuli I_c/V_c .

Copy Right Reserved JZWI-DS-011 Version 2.3



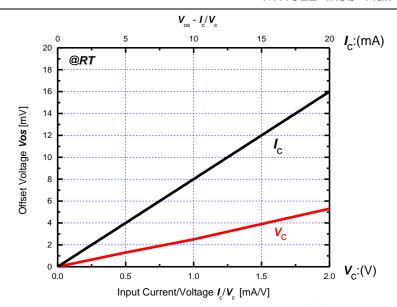


Figure 6. Offset voltage V_{os} as a function of electrical stimuli I_c/V_c .

Matrixopto.Co.,Ltd is the owner of the trademarks used in this document, which has the exclusive right to prevent any third parties not having the owner's consent from using in the course of trade identical or similar signs for goods or services where such use would result in a likelihood of confusion.



Reliability Test Terms

Table 2. Reliability Test Terms, Conditions and Duration.

| No. | Terms | Conditions | Duration |
|-----|--|---|-----------|
| 1 | High Temperature Storage (HTS) | 【JEITA EIAJ ED-4701】 7a =150 (0 ~ +10) °C | 1000 hrs |
| 2 | Heat Cycle (HC) | 【JEITA EIAJ ED-4701】 $T_a=-55^{\circ}\text{C}\sim150 ^{\circ}\text{C}$ high temp normal temp low temp. $30 \text{min} - 5 \text{min} - 30 \text{min}$ | 30 cycles |
| 3 | Temp. Humidity Storage (THS) | [JEITA EIAJ ED-4701] $T_a = 85 \pm 3 ^{\circ}\text{C}$, $R_H = 85 \pm 5 ^{\circ}\text{M}$ | 1000 hrs |
| 4 | Resist. to Hand Soldering Heat (RHSH) | 【JEITA EIAJ ED-4701】 Dipped in the 300±5 ℃ solder up to the 1 mm part from the body | 5 sec |
| 5 | High Temp. Operating (HTO) | \mathcal{T}_{a} =125 °C , \mathcal{V}_{c} =1V | 1000 hrs |

Criteria:

- Variation of Hall Voltage $\it V_{\rm H}$ and input/output resistances $\it R_{\rm in/out}$ are less than 20%.
- Variation of offset voltage V_{os} is less than ± 16 mV.
- Other parameters in Table 1. are still within their ranges stated in Table 1.

Matrixopto.Co.,Ltd is the owner of the trademarks used in this document, which has the exclusive right to prevent any third parties not having the owner's consent from using in the course of trade identical or similar signs for goods or services where such use would result in a likelihood of confusion.



Matrix Opto. Co., Ltd -MW922 InSb Hall Element-

Soldering Conditions

The following conditions should be preserved. Solder ability should be checked by yourself, because it is depend on solder paste material and other parameters.

Material of solder flux

- Use the resin based flux and refrain from using organic or inorganic acid based and water-soluble one.

Cleansing of solder flux conditions

- Use Ethanol or Isopropyl alcohol as cleansing material.
- Process temperature should be 50 °C or less.
- Duration should be 5 minutes or less.

Hand soldering conditions

- Apart from the mold resin more than 1mm.
- Solder at temperature 300 °C for less than 5s.

Wave soldering conditions

- Temperature in Pre-heating zone should be lower than 150°C.
- Temperature in Soldering zone should be lower than 280°C.



Precautions for ESD

This product is the device that is sensitive to ESD (Electrostatic Discharge). Handling Hall Elements with the ESD-Caution mark under the environment in which

- Static electrical charge is unlikely to arise (Ex: Relative Humidity over 40%RH).
- Wearing the anti-static suit and wristband when handling the devices.
- Implementing measures against ESD as for containers that directly touch the devices.

Precautions for Storage

- Products should be stored at an appropriate temperature and humidity (5°C to 35°C, 40%RH to 60%RH) after the unsealing of the MBB. Keeping products away from chlorine and corrosive gas.
- For storage longer than 2 years

Products are sealed in MBB with a desiccant. It is recommended to store in nitrogen atmosphere with MBB sealed. Oxygen and H_2O of atmosphere oxidizes leads of products and lead solder ability get worse.

Precautions for Safety

- Do not alter the form of this product into a gas, powder or liquid through burning, crushing or chemical processing.
- Observe laws and company regulations when discarding this product.